Parallel connection pin for surface mounting HDA series (10pcs/pack)

- This connection pin can connect the PC boards for surface mounting in parallel.
- The socket side is the HDB series described below.
- Two types (with a pitch of 1.27 mm and 2.54 mm) are available.
- Material Pin part: Phosphor bronze
- Resin part: PCT black (UL94V-0) • Finish: Gold plating over nickel base
- Finish: Gold plating of
 Rated current: 2A
- Withstand voltage: 700V AC, DC per minute (HDA-1-1) 1000V AC, DC per minute (HDA-3-1)
- Insulation resistance: 500M Ω or over
- Operating temperature range: − 40 to + 125℃

Part No.

Part No.	Р	А	Maximum number of pins connected
HDA-1-1	1.27	50.8	40
HDA-3-1	2.54	49.53	20

How to order



Please fill in the desired number of poles. * If the number of poles is not specified, we will deliver the maximum connected number.

Instructions for mounting

In the case that a warpage occurs on the resin part during reflow because many pins are connected for use, apply an adhesive to several places. * HDA-1-1-2P: Taping specification is available. Please

* HDA-1-1-2P: Taping specification is available. Please contact us.

Parallel connection socket for surface mounting

HDB series (10pcs/pack)

- By combining with HDA series described above, PC boards can be connected in parallel.
- By combining with OQ series, PC boards can be connected vertically.
- Two types (with a pitch of 1.27mm and 2.54mm) are available.
- Material Body: Brass
 - Contact: Beryllium copper
 - Resin part: PCT black (UL94V-0)
- Finish: Gold plating over nickel base
- Rated current: 1A
- Withstand voltage: 500V AC, DC per minute (HDB-1-1)
- 1000V AC, DC per minute (HDB-3-1)
- \bullet Insulation resistance: 500M Ω or over
- Contact resistance: $10m \Omega$ or less
- Insertion / removal durability : 100 cycles
- Insertion / removal forces: 30g or over (per pin)
- Adaptive male pin diameter: ϕ 0.4 to ϕ 0.5
- Operating temperature range: 40 to + 125 $\ensuremath{\mathbb{C}}$



HDB-1-1-10P

How to order

Please fill in the number of poles.

Instructions for mounting

In the case that a warpage occurs on the resin part during reflow due to many pins are connected for use, apply an adhesive to several places. * HDB-1-1-2P: Taping specification is available.

Please contact us.





Recommended land information





Example of usage



HDA-1-1 and HDB-1-1



HDA-3-1





Example of usage

HDA-1-1 and HDB-1-1



Recommended land information



* Instructions for use

When it is used in combination, the strength is poor. Please fix the PC boards to a chassis or fix the PC boards each other with AXH series.

* If the number of poles is not specified, we will deliver the maximum connected number.